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Category:Universal Windows Platform apps Category:Windows multimedia software Category:Pro audio software Category:Digital audio editorsLouis-Léandre Dufour Louis-Léandre Dufour (January 25, 1803 – June 18, 1848) was a physician and political figure in Lower Canada and Canada East. He represented Montcalm in the Legislative Assembly of Lower Canada from 1826 to 1830. He was born Louis-François Dufour in Saint-Jean, Lower Canada, the son of Louis Dufour and Marie-Louise Richard, and was educated at the Petit Séminaire de Saint-Hyacinthe and the Petit Séminaire de Québec. He qualified as a doctor in 1822 and set up practice in Pointe-aux-Trembles. Dufour married Anne-Julie Barbeau, the sister of Antoine Barbeau, in 1833. He served as coroner for the district of Saint-Jean. He was also a justice of the peace. References Category:1803 births Category:1848 deaths Category:Members of the Legislative Assembly of Lower Canada Category:Canadian coronersThe present invention relates generally to the field of cooling electronic circuit components, and, more particularly, to a system and method for cooling a semiconductor chip mounted on a ceramic substrate. A semiconductor chip or die is a small device containing thousands or millions of tiny transistors and other electronic components. Each chip is typically housed in a package that protects the chip from physical damage and that provides power and signal interconnects to the chip. In recent years, however, there has been a push to integrate as much of the functionality of the chip into the package itself. This has created a demand for smaller, thinner and lighter packages, because the space required by a larger package increases the distance between the circuitry and the heat sink that is used to cool the package. Most high-performance microprocessors and microcontrollers are highly susceptible to damage from electrostatic discharge (ESD). ESD pulses create a high voltage across a surface that has a very low capacitance and an uninsulated underlying structure. These pulses may cause the chip to “latch up” and damage the chip. Therefore, many semiconductor chip packages have a layer of glass over the circuitry, with the glass being bonded to the ceramic substrate that holds the die. The glass 2d92ce491b